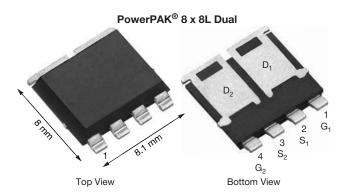


Vishay Siliconix

Automotive Dual N-Channel 80 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY			
V _{DS} (V)	80		
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.0135		
$R_{DS(on)}$ (Ω) at $V_{GS} = 4.5 \text{ V}$	0.0170		
I _D (A) per leg	36		
Configuration	Dual		
Package	PowerPAK 8 x 8L		

FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Fully lead (Pb)-free device
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





COMPLIANT HALOGEN FREE

G ₁ O S ₁	G_2 G_2 G_2
N-Channel MOSFET	N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S ($T_C = 25 ^{\circ}C$, unless	s otherwise noted	d)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	80	.,	
Gate-source voltage		V _{GS}	± 20	V	
Continuous drain current	T _C = 25 °C ^a	1	36		
	T _C = 125 °C	I _D	21		
Continuous source current (diode conduction) a		I _S	34	Α	
Pulsed drain current ^b		I _{DM}	128		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	27		
Single pulse avalanche energy	L = 0.1 IIII	E _{AS}	36	mJ	
Maximum power dissipation ^b	T _C = 25 °C	D	187	W	
	T _C = 125 °C	P_{D}	62		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) d, e		-	260		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount c	R_{thJA}	100	°C/W	
Junction-to-case (drain)		R_{thJC}	4.0	C/VV	

Notes

- a. Package limited
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 8 x 8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				l			ı
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0$, $I_D = 250 \mu A$		80	-	-	- V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		2	2.5	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Zero gate voltage drain current		V _{GS} = 0 V	V _{DS} = 20 V	-	-	1	μА
	I _{DSS}	V _{GS} = 0 V	V _{DS} = 80 V, T _J = 125 °C	-	-	50	
		V _{GS} = 0 V	V _{DS} = 80 V, T _J = 175 °C	-	-	150	
On-state drain current a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	40	-	-	Α
Drain-source on-state resistance ^a		V _{GS} = 10 V	I _D = 5 A	-	0.0036	0.0135	Ω
	В	V _{GS} = 4.5 V	I _D = 5 A	-	0.0045	0.0170	
	R _{DS(on)}	V _{GS} = 10 V	I _D = 5 A, T _J = 125 °C	-	-	0.0220	
		V _{GS} = 10 V	I _D = 5 A, T _J = 175 °C	-	-	0.0280	
Forward Transconductance b	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		-	55	-	S
Dynamic ^b							
Input capacitance	C _{iss}			-	1595	1995	pF
Output capacitance	C _{oss}	$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, f = 1 \text{ MHz}$	-	616	770	
Reverse transfer capacitance	C _{rss}			-	23	30	
Total gate charge ^c	Qg		V _{GS} = 10 V V _{DS} = 40 V, I _D = 10 A	-	26	36	nC
Gate-source charge ^c	Q _{gs}	V _{GS} = 10 V		-	5	1	
Gate-drain charge ^c	Q_{gd}			-	4	-	
Gate resistance	R_g	f = 1 MHz		0.7	1.1	1.9	Ω
Turn-on delay time ^c	t _{d(on)}			-	10	14	
Rise time ^c	t _r	$V_{DD} = 40 \text{ V}, \text{ R}_L = 4 \Omega$ $I_D \cong 10 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		-	3	5	ns
Turn-off delay time ^c	t _{d(off)}			-	21	27	
Fall time ^c	t _f			-	3	5	
Source-Drain Diode Ratings and Char	acteristics ^b						
Pulsed current ^a	I _{SM}			-	-	128	Α
Forward voltage	V _{SD}	$I_F = 40 \text{ A}, V_{GS} = 0$		_	1	1.2	V

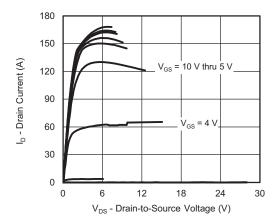
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

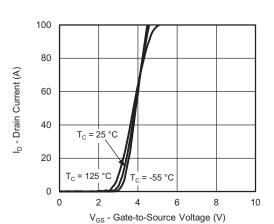
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



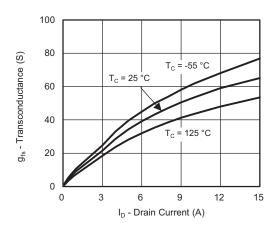
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



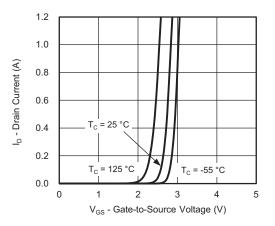
Output Characteristics



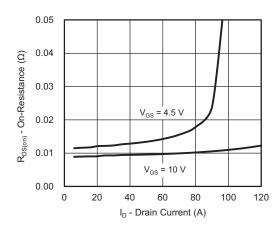
Transfer Characteristics



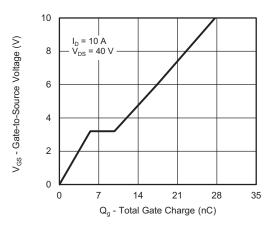
Transconductance



Transfer Characteristics



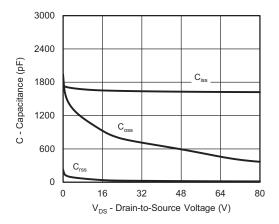
On-Resistance vs. Drain Current



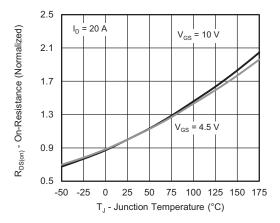
Capacitance



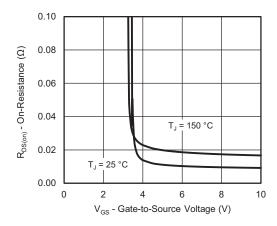
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



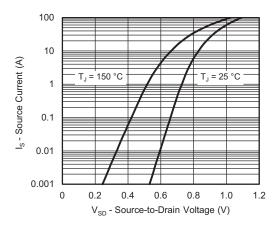
Capacitance



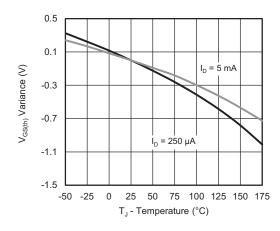
On-Resistance vs. Junction Temperature



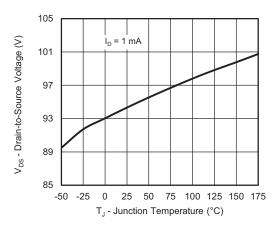
On-Resistance vs. Gate-to-Source Voltage



Source Drain Diode Forward Voltage



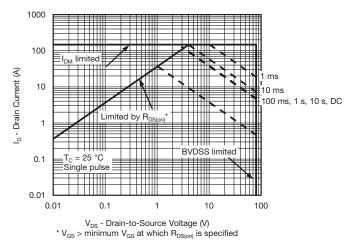
Threshold Voltage



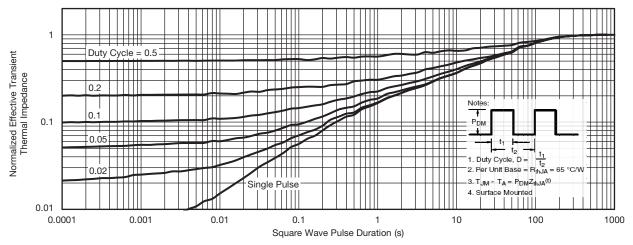
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



Safe Operating Area

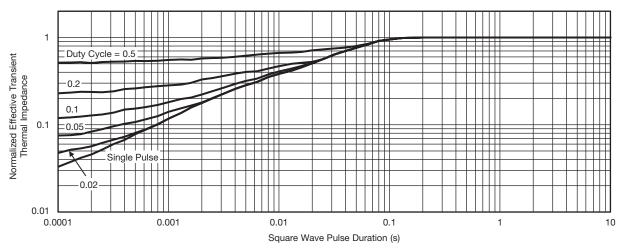


Normalized Thermal Transient Impedance, Junction-to-Ambient

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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